



566.43481VC5

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants: N. FUKUTOMI, et al.
Application No.: 10/705,706
Filed: November 10, 2003
For: FABRICATION PROCESS OF SEMICONDUCTOR
PACKAGE AND SEMICONDUCTOR PACKAGE
Art Unit: Unknown
Examiner: Unknown

INFORMATION DISCLOSURE STATEMENT
UNDER 37 CFR §§ 1.97 & 1.98

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

April 5, 2004

Sir:

Pursuant to Applicants' duty of disclosure, enclosed please find an Office Action dated January 5, 2004, in connection with an European Patent Application corresponding to the above-identified application. Also enclosed is a copy of the document newly cited in this Office Action, together with an English Abstract thereof. Further enclosed is Form PTO/SB/08A, listing the enclosed documents.

This Information Disclosure Statement is being submitted prior to a first Office Action on the merits in the above-identified application. Accordingly, requirements of 37 CFR § 1.97(b) are clearly satisfied.

In any event, the following statement is made under 37 CFR § 1.97(e):

Each item of information contained in this Information Disclosure Statement was first cited in any communication from a foreign patent office in a counterpart foreign application not more than

three months prior to the filing of this Information Disclosure Statement.


To the extent that the enclosed documents are not in English, it is respectfully submitted that requirements of 37 CFR § 1.98(a)(3) are satisfied by the enclosed Office Action and/or enclosed English Abstract.

In view of the foregoing, it is respectfully submitted that all applicable requirements of 37 CFR §§ 1.97 and 1.98 have been satisfied, in connection with the documents listed on the enclosed Form. Accordingly, consideration of the listed documents, upon further examination of the above-identified application, is respectfully requested.

To the extent necessary, Applicants petition for an extension of time under 37 CFR 1.136. Please charge any shortage in fees due in connection with the filing of this paper, including extension of time fees, to the Antonelli, Terry, Stout & Kraus, LLP Deposit Account No. 01-2135 (Docket No. 566.43481VC5), and please credit any excess fees to such Deposit Account.

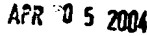
Respectfully submitted,

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Application Number	10/705,706
Filing Date	November 10, 2003
First Named Inventor	N. FUKUTOMI, et al.
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Examiner Initials ¹	Cite No. ¹	Document Number	Publication Date MM-DD-YYYY	Name of Patentee or Applicant of Cited Document	Pages, Columns, Lines, Where Relevant Passages or Relevant Figures Appear
		Number-Kind Code ² (if known)			

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Date
Considered

Burden Hour Statement: This form is estimated to take 2.0 hours to complete. Time will vary depending upon the needs of the individual case. Any comments on the amount of time you are required to complete this form should be sent to the Chief Information Officer, U.S. Patent and Trademark Office, Washington, DC 20231. **DO NOT SEND FEES OR COMPLETED FORMS TO THIS ADDRESS. SEND TO:** Assistant Commissioner for Patents, Washington, DC 20231.